

Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	297
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12e-6f484c

Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
Packages and SERDES / I/O Combinations					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

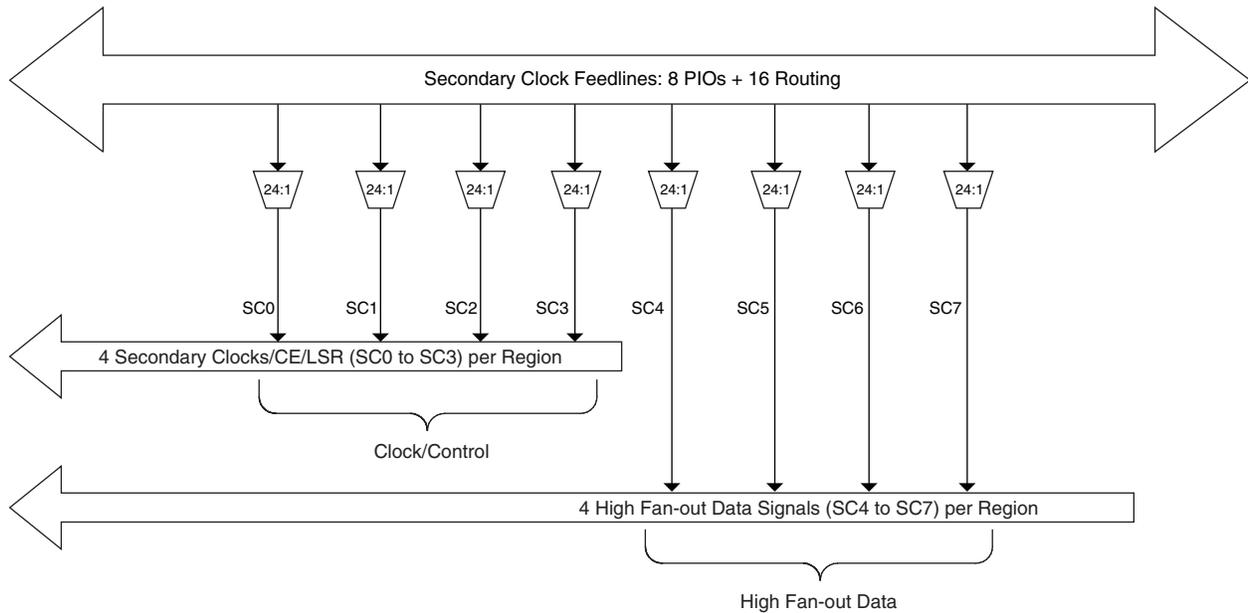
The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Figure 2-16. Secondary Clock Selection



Slice Clock Selection

Figure 2-17 shows the clock selections and Figure 2-18 shows the control selections for Slice0 through Slice2. All the primary clocks and the four secondary clocks are routed to this clock selection mux. Other signals can be used as a clock input to the slices via routing. Slice controls are generated from the secondary clocks or other signals connected via routing.

If none of the signals are selected for both clock and control then the default value of the mux output is 1. Slice 3 does not have any registers; therefore it does not have the clock or control muxes.

Figure 2-17. Slice0 through Slice2 Clock Selection

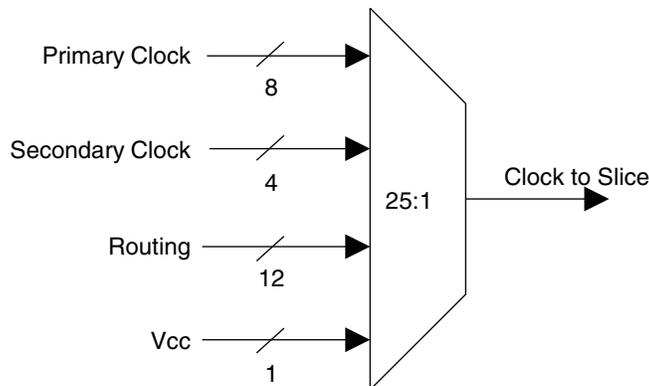
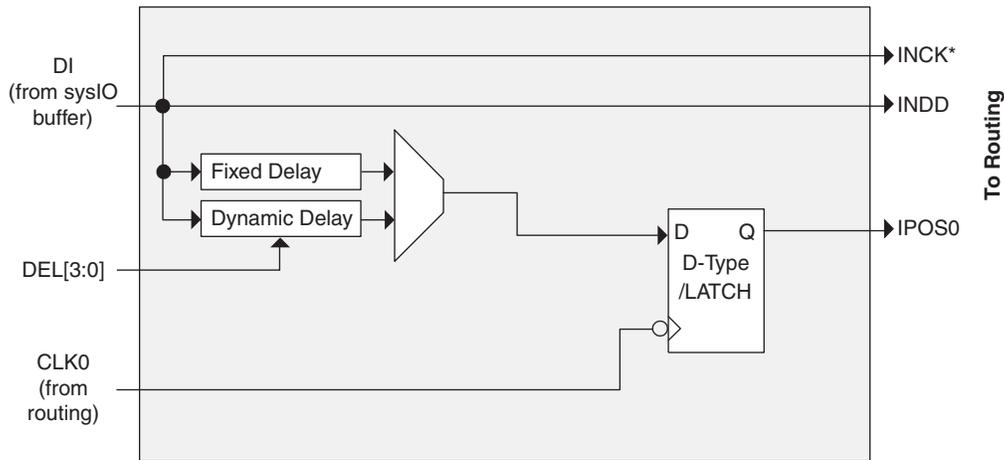


Figure 2-30. Input Register Block Top Edge



Note: Simplified version does not show CE and SET/RESET details.
*On selected blocks.

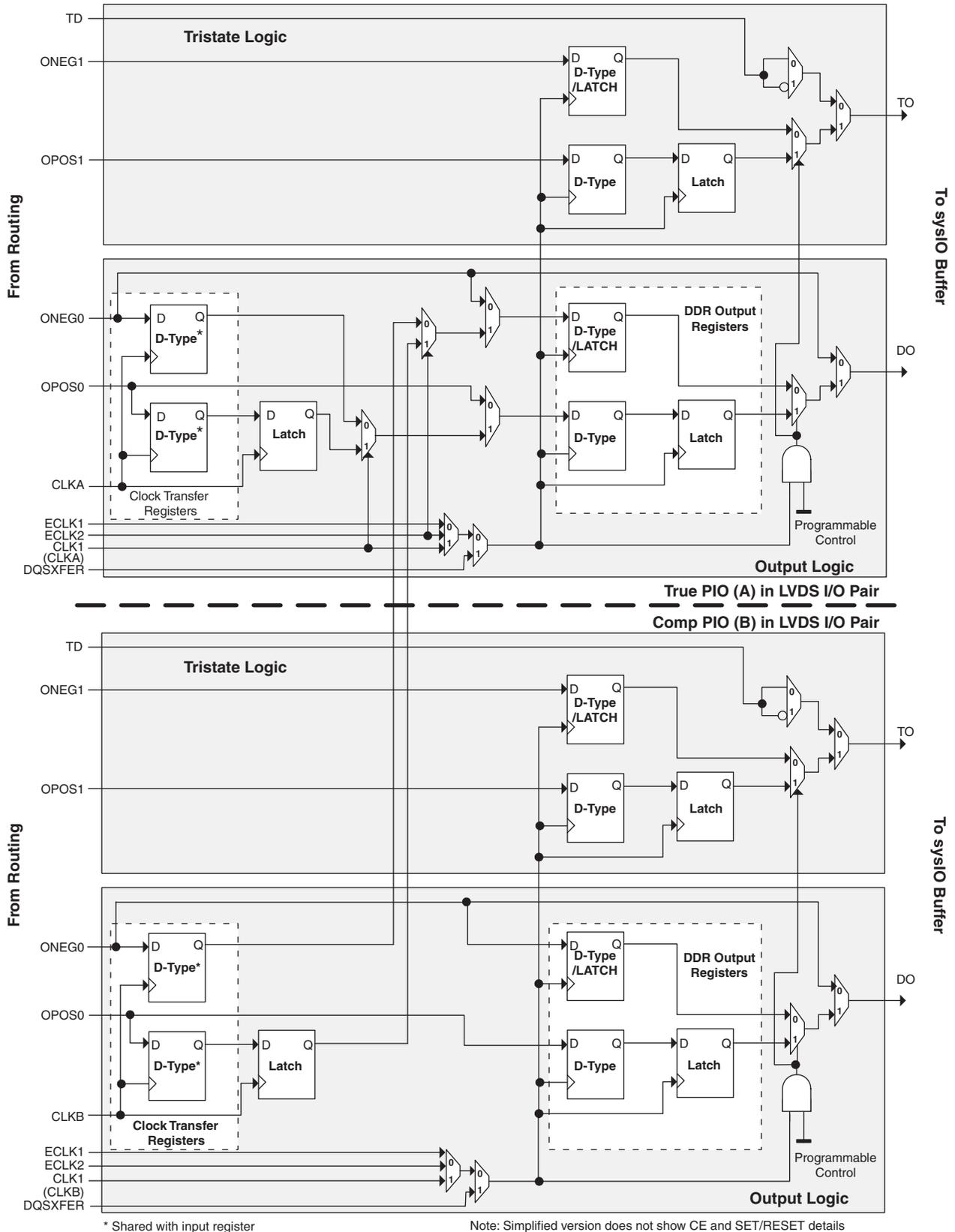
Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The blocks on the PIOs on the left, right and bottom contain a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-31 shows the diagram of the Output Register Block for PIOs on the left, right and the bottom edges. Figure 2-32 shows the diagram of the Output Register Block for PIOs on the top edge of the device.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured as a D-type or latch. In DDR mode, ONEG0 and OPOS0 are fed into registers on the positive edge of the clock. Then at the next clock cycle this registered OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

By combining the output blocks of the complementary PIOs and sharing some registers from input blocks, a gearbox function can be implemented, that takes four data streams: ONEG0A, ONEG1A, ONEG1B and ONEG1B. Figure 2-32 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

Figure 2-31. Output and Tristate Block for Left, Right and Bottom Edges



LatticeECP2/M Internal Switching Characteristics¹

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
PFU/PFF Logic Mode Timing								
t _{LUT4_PFU}	LUT4 delay (A to D inputs to F output)	—	0.180	—	0.198	—	0.216	ns
t _{LUT6_PFU}	LUT6 delay (A to D inputs to OFX output)	—	0.304	—	0.331	—	0.358	ns
t _{LSR_PFU}	Set/Reset to output of PFU (Asynchronous)	—	0.600	—	0.655	—	0.711	ns
t _{SUM_PFU}	Clock to Mux (M0,M1) Input Setup Time	0.128	—	0.129	—	0.129	—	ns
t _{HM_PFU}	Clock to Mux (M0,M1) Input Hold Time	-0.051	—	-0.049	—	-0.046	—	ns
t _{SUD_PFU}	Clock to D input setup time	0.061	—	0.071	—	0.081	—	ns
t _{HD_PFU}	Clock to D input hold time	0.002	—	0.003	—	0.003	—	ns
t _{CK2Q_PFU}	Clock to Q delay, (D-type Register Configuration)	—	0.285	—	0.309	—	0.333	ns
PFU Dual Port Memory Mode Timing								
t _{CORAM_PFU}	Clock to Output (F Port)	—	0.902	—	1.083	—	1.263	ns
t _{SUDATA_PFU}	Data Setup Time	-0.172	—	-0.205	—	-0.238	—	ns
t _{HDATA_PFU}	Data Hold Time	0.199	—	0.235	—	0.271	—	ns
t _{SUADDR_PFU}	Address Setup Time	-0.245	—	-0.284	—	-0.323	—	ns
t _{HADDR_PFU}	Address Hold Time	0.246	—	0.285	—	0.324	—	ns
t _{SUWREN_PFU}	Write/Read Enable Setup Time	-0.122	—	-0.145	—	-0.168	—	ns
t _{HWREN_PFU}	Write/Read Enable Hold Time	0.132	—	0.156	—	0.180	—	ns
PIC Timing								
PIO Input/Output Buffer Timing								
t _{IN_PIO}	Input Buffer Delay (LVCMOS25)	—	0.613	—	0.681	—	0.749	ns
t _{OUT_PIO}	Output Buffer Delay (LVCMOS25)	—	1.115	—	1.115	—	1.343	ns
IOLOGIC Input/Output Timing								
t _{SUI_PIO}	Input Register Setup Time (Data Before Clock)	0.596	—	0.645	—	0.694	—	ns
t _{HI_PIO}	Input Register Hold Time (Data after Clock)	-0.570	—	-0.614	—	-0.658	—	ns
t _{COO_PIO}	Output Register Clock to Output Delay	—	0.61	—	0.66	—	0.72	ns
t _{SUCE_PIO}	Input Register Clock Enable Setup Time	0.032	—	0.037	—	0.041	—	ns
t _{HCE_PIO}	Input Register Clock Enable Hold Time	-0.022	—	-0.025	—	-0.028	—	ns
t _{SULSR_PIO}	Set/Reset Setup Time	0.184	—	0.201	—	0.217	—	ns
t _{HLSR_PIO}	Set/Reset Hold Time	-0.080	—	-0.086	—	-0.093	—	ns
EBR Timing								
t _{CO_EBR}	Clock (Read) to output from Address or Data	—	2.51	—	2.75	—	2.99	ns
t _{COO_EBR}	Clock (Write) to output from EBR output Register	—	0.33	—	0.36	—	0.39	ns
t _{SUDATA_EBR}	Setup Data to EBR Memory	-0.157	—	-0.181	—	-0.205	—	ns
t _{HDATA_EBR}	Hold Data to EBR Memory	0.173	—	0.195	—	0.217	—	ns
t _{SUADDR_EBR}	Setup Address to EBR Memory	-0.115	—	-0.130	—	-0.145	—	ns
t _{HADDR_EBR}	Hold Address to EBR Memory	0.138	—	0.155	—	0.172	—	ns
t _{SUWREN_EBR}	Setup Write/Read Enable to PFU Memory	-0.128	—	-0.149	—	-0.170	—	ns

LatticeECP2 Power Supply and NC

Signals	144 TQFP ³	208 PQFP ³	256 fpBGA ⁴	484 fpBGA ⁴
VCC	16, 22, 29, 48, 54, 83, 94, 102, 128, 135	12, 19, 28, 40, 74, 80, 97, 116, 129, 140, 146, 171, 188, 198	LFE2-6: G7, G9, G10, H7, J10, K10, K8 LFE2-12/LFE2-20: G7, G9, G10, H7, J10, K10, K8	LFE2-12/LFE2-20: N6, N18, J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13 LFE2-35/LFE2-50: J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13
VCCIO0	139	195, 206	C5, E7	G10, G9, H8, H9
VCCIO1	117	162, 170	C12, E10	G11, G12, G13, G14
VCCIO2	106	143, 148	E14, G12	H14, H15, J15, K16
VCCIO3	89	123, 135	K12, M14	L16, M16, N16, P16
VCCIO4	64	93, 100	M10, P12	R14, T12, T13, T14
VCCIO5	42	55, 63	M7, P5	R9, T10, T11, T9
VCCIO6	31	38, 44	K5, M3	N7, P7, P8, R8
VCCIO7	9	10, 14	E3, G5	J8, K7, L7, M7
VCCIO8	85	113, 118	T15	P15, R15
VCCJ	35	51	K7	T8
VCCAUX	6, 39, 90, 142	7, 30, 70, 86, 125, 151, 174, 190	G8, H10, J7, K9	G5, K5, R5, V7, V11, V8, V13, V15, M17, P17, E17, G18, D11, F13, C5, E6
VCCPLL	None	None	None	LFE2-12/LFE2-20: None LFE2-35: N6, N18 LFE2-50: N6, N18, K6, J16
GND ¹	11, 21, 30, 47, 51, 61, 81, 95, 105, 120, 133, 138	5, 13, 17, 25, 32, 42, 60, 68, 77, 81, 89, 102, 115, 122, 139, 145, 159, 169, 175, 184, 192, 201	A1, A16, B12, B5, C8, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16	A22, AA19, AA4, AB1, AB22, B19, B4, C14, C9, D2, D21, F17, F6, H10, H11, H12, H13, J14, J20, J3, J9, K10, K11, K12, K13, K15, K8, L10, L11, L12, L13, L15, L8, M10, M11, M12, M13, M15, M8, N10, N11, N12, N13, N15, N8, P14, P20, P3, P9, R10, R11, R12, R13, U17, U6, W2, W21, Y14, Y9, A1
NC ²	LFE2-6: 45, 46, 124, 127 LFE2-12: 127	None	LFE2-6: K6, R3, P4 LFE2-12/LFE2-20: None	LFE2-12: E3, F3, F1, H4, F2, H5, G1, G3, G2, G4, K6, N1, M2, N2, M1, N3, N5, N4, P5, N19, M19, J22, L22, H22, K22, J16, D22, F21, E21, E22, H19, G20, G19, F20, C21, C22, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-20/LFE2-35: K6, J16, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-50: None

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. Pin orientation follows the conventional order from the pin 1 marking of the top side view and counter-clockwise.
4. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
M8	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C	
GND	GNDIO5	-			GNDIO5	-			
P7	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T	
R8	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C	
VCCIO	VCCIO4	4			VCCIO4	4			
T5	PB14A	4	BDQ15	T	PB32A	4	BDQ33	T	
T6	PB14B	4	BDQ15	C	PB32B	4	BDQ33	C	
T8	PB15A	4	BDQS15	T	PB33A	4	BDQS33	T	
GND	GNDIO4	-			GNDIO4	-			
R7	PB16A	4	BDQ15	T	PB34A	4	BDQ33	T	
T9	PB15B	4	BDQ15	C	PB33B	4	BDQ33	C	
T7	PB16B	4	BDQ15	C	PB34B	4	BDQ33	C	
L8	PB17A	4	BDQ15	T	PB35A	4	BDQ33	T	
VCCIO	VCCIO4	4			VCCIO4	4			
P8	PB18A	4	BDQ15	T	PB36A	4	BDQ33	T	
L9	PB17B	4	BDQ15	C	PB35B	4	BDQ33	C	
N8	PB18B	4	BDQ15	C	PB36B	4	BDQ33	C	
R9	PB19A	4	BDQ15	T	PB37A	4	BDQ33	T	
GND	GNDIO4	-			GNDIO4	-			
R10	PB19B	4	BDQ15	C	PB37B	4	BDQ33	C	
-	-	-			VCCIO	4			
-	-	-			GNDIO4	4			
N9	PB20A	4	BDQ24	T	PB47A	4	BDQ51	T	
T10	PB21A	4	BDQ24	T	PB48A	4	BDQ51	T	
M9	PB20B	4	BDQ24	C	PB47B	4	BDQ51	C	
R11	PB21B	4	BDQ24	C	PB48B	4	BDQ51	C	
P10	PB22A	4	BDQ24	T	PB49A	4	BDQ51	T	
N11	PB23A	4	BDQ24	T	PB50A	4	BDQ51	T	
VCCIO	VCCIO4	4			VCCIO4	4			
N10	PB22B	4	BDQ24	C	PB49B	4	BDQ51	C	
P11	PB23B	4	BDQ24	C	PB50B	4	BDQ51	C	
T11	PB24A	4	BDQS24	T	PB51A	4	BDQS51	T	
GND	GNDIO4	-			GNDIO4	-			
M11	PB25A	4	BDQ24	T	PB52A	4	BDQ51	T	
T12	PB24B	4	BDQ24	C	PB51B	4	BDQ51	C	
L11	PB25B	4	BDQ24	C	PB52B	4	BDQ51	C	
T13	PB26A	4	BDQ24	T	PB53A	4	BDQ51	T	
R13	PB27A	4	BDQ24	T	PB54A	4	BDQ51	T	
VCCIO	VCCIO4	4			VCCIO4	4			
T14	PB26B	4	BDQ24	C	PB53B	4	BDQ51	C	
P13	PB27B	4	BDQ24	C	PB54B	4	BDQ51	C	
GND	GNDIO4	-			GNDIO4	-			
N12	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T	
M12	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C	
R15	CFG2	8			CFG2	8			

LFE2-20E/SE Logic Signal Connections: 256 fpBGA

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C3	C3	PL2A	7	VREF2_7	T (LVDS)*
C2	C2	PL2B	7	VREF1_7	C (LVDS)*
VCCIO	VCCIO	VCCIO7	7		
-	GND	GNDIO7	7		
D3	D3	PL7A	7	LDQ8	T
D4	D4	PL6A	7	LDQ8	T (LVDS)*
D2	D2	PL7B	7	LDQ8	C
GND	GND	GNDIO7	-		
E4	E4	PL6B	7	LDQ8	C (LVDS)*
B1	B1	PL13A	7	LDQ16	T
C1	C1	PL13B	7	LDQ16	C
F5	F5	PL15A	7	LDQ16	T
VCCIO	VCC	VCCIO	7		
F4	F4	PL14A	7	LDQ16	T (LVDS)*
G6	G6	PL15B	7	LDQ16	C
G4	G4	PL14B	7	LDQ16	C (LVDS)*
D1	D1	PL16A	7	LDQS16	T (LVDS)*
GND	GND	GNDIO7	-		
E1	E1	PL16B	7	LDQ16	C (LVDS)*
F3	F3	PL17A	7	LDQ16	T
G3	G3	PL17B	7	LDQ16	C
VCCIO	VCCIO	VCCIO7	7		
F2	F2	PL18A	7	LDQ16	T (LVDS)*
F1	F1	PL18B	7	LDQ16	C (LVDS)*
GND	GND	GNDIO7	-		
G2	G2	PL19A	7	PCLKT7_0/LDQ16	T
G1	G1	PL19B	7	PCLKC7_0/LDQ16	C
H6	H6	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*
VCCIO	VCCIO	VCCIO6	6		
H5	H5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*
H4	H4	PL22A	6	VREF2_6/LDQ25	T
GND	GND	GNDIO6	-		
H3	H3	PL22B	6	VREF1_6/LDQ25	C
H2	H2	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*
H1	H1	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*
G10	G10	VCC	-		
J4	J4	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T
J5	J5	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C
J6	J6	LLM0_PLLCAP	6		
K4	K4	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*
GND	GND	GNDIO6	-		

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA
(Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U3	PL55A	6	LDQ56	T	PL74A	6	LDQ75	T
U4	PL55B	6	LDQ56	C	PL74B	6	LDQ75	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL56A	6	LDQS56	T (LVDS)*	PL75A	6	LDQS75	T (LVDS)*
W1	PL56B	6	LDQ56	C (LVDS)*	PL75B	6	LDQ75	C (LVDS)*
R7	PL57A	6	LDQ56	T	PL76A	6	LDQ75	T
VCCIO	VCCIO6	6			VCCIO	6		
T7	PL57B	6	LDQ56	C	PL76B	6	LDQ75	C
V4	PL58A	6	LDQ56	T (LVDS)*	PL77A	6	LDQ75	T (LVDS)*
V3	PL58B	6	LDQ56	C (LVDS)*	PL77B	6	LDQ75	C (LVDS)*
AA2	PL59A	6	LDQ56	T	PL78A	6	LDQ75	T
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL59B	6	LDQ56	C	PL78B	6	LDQ75	C
U7	TCK	-			TCK	-		
U5	TDI	-			TDI	-		
V5	TMS	-			TMS	-		
V6	TDO	-			TDO	-		
T8	VCCJ	-			VCCJ	-		
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
VCCIO	VCCIO5	5			VCCIO	5		
W7	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
W8	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
Y6	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
Y7	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AA7	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO	5		
AB7	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C

**LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA
 (Cont.)**

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N16	VCCIO3	3			VCCIO3	3		
P16	VCCIO3	3			VCCIO3	3		
R14	VCCIO4	4			VCCIO4	4		
T12	VCCIO4	4			VCCIO4	4		
T13	VCCIO4	4			VCCIO4	4		
T14	VCCIO4	4			VCCIO4	4		
R9	VCCIO5	5			VCCIO5	5		
T10	VCCIO5	5			VCCIO5	5		
T11	VCCIO5	5			VCCIO5	5		
T9	VCCIO5	5			VCCIO5	5		
N7	VCCIO6	6			VCCIO6	6		
P7	VCCIO6	6			VCCIO6	6		
P8	VCCIO6	6			VCCIO6	6		
R8	VCCIO6	6			VCCIO6	6		
J8	VCCIO7	7			VCCIO7	7		
K7	VCCIO7	7			VCCIO7	7		
L7	VCCIO7	7			VCCIO7	7		
M7	VCCIO7	7			VCCIO7	7		
P15	VCCIO8	8			VCCIO8	8		
R15	VCCIO8	8			VCCIO8	8		
A22	GND	-			GND	-		
AA19	GND	-			GND	-		
AA4	GND	-			GND	-		
AB1	GND	-			GND	-		
AB22	GND	-			GND	-		
B19	GND	-			GND	-		
B4	GND	-			GND	-		
C14	GND	-			GND	-		
C9	GND	-			GND	-		
D2	GND	-			GND	-		
D21	GND	-			GND	-		
F17	GND	-			GND	-		
F6	GND	-			GND	-		
H10	GND	-			GND	-		
H11	GND	-			GND	-		
H12	GND	-			GND	-		
H13	GND	-			GND	-		
J14	GND	-			GND	-		
J20	GND	-			GND	-		
J3	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K12	GND	-			GND	-		
K13	GND	-			GND	-		
K15	GND	-			GND	-		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA
(Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W5	PL71B	6	LDQ75	C (LVDS)*	PL84B	6	LDQ88	C (LVDS)*
AC1	PL72A	6	LDQ75	T	PL85A	6	LDQ88	T
AD1	PL72B	6	LDQ75	C	PL85B	6	LDQ88	C
VCCIO	VCCIO6	6			VCCIO6	6		
Y6	PL73A	6	LDQ75	T (LVDS)*	PL86A	6	LDQ88	T (LVDS)*
Y5	PL73B	6	LDQ75	C (LVDS)*	PL86B	6	LDQ88	C (LVDS)*
AE2	PL74A	6	LDQ75	T	PL87A	6	LDQ88	T
AD2	PL74B	6	LDQ75	C	PL87B	6	LDQ88	C
GND	GNDIO6	-			GNDIO6	-		
AB3	PL75A	6	LDQS75	T (LVDS)*	PL88A	6	LDQS88	T (LVDS)*
AB2	PL75B	6	LDQ75	C (LVDS)*	PL88B	6	LDQ88	C (LVDS)*
W7	PL76A	6	LDQ75	T	PL89A	6	LDQ88	T
VCCIO	VCCIO6	6			VCCIO6	6		
W8	PL76B	6	LDQ75	C	PL89B	6	LDQ88	C
Y7	PL77A	6	LDQ75	T (LVDS)*	PL90A	6	LDQ88	T (LVDS)*
Y8	PL77B	6	LDQ75	C (LVDS)*	PL90B	6	LDQ88	C (LVDS)*
AC2	PL78A	6	LDQ75	T	PL91A	6	LDQ88	T
GND	GNDIO6	-			GNDIO6	-		
AD3	PL78B	6	LDQ75	C	PL91B	6	LDQ88	C
AC3	TCK	-			TCK	-		
AA8	TDI	-			TDI	-		
AB4	TMS	-			TMS	-		
AA5	TDO	-			TDO	-		
AB5	VCCJ	-			VCCJ	-		
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
GND	GNDIO5	-			GNDIO5	-		
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO7	7		
F4	PL2A	7	VREF2_7	T (LVDS)*
F3	PL2B	7	VREF1_7	C (LVDS)*
H4	PL3A	7		T
G5	PL3B	7		C
GND	GNDIO7	-		
D2	PL4A	7		T (LVDS)*
D1	PL4B	7		C (LVDS)*
E2	PL5A	7		T
VCCIO	VCCIO7	7		
E1	PL5B	7		C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
F1	PL14A	7	LUM1_SPLLT_IN_A/LDQ12	T (LVDS)*
F2	PL14B	7	LUM1_SPLLC_IN_A/LDQ12	C (LVDS)*
G1	PL15A	7	LUM1_SPLLT_FB_A/LDQ12	T
G2	PL15B	7	LUM1_SPLLC_FB_A/LDQ12	C
GND	GNDIO7	-		
H8	PL18A	7	LDQ21	T
H6	PL18B	7	LDQ21	C
VCCIO	VCCIO7	7		
G4	PL19A	7	LDQ21	T (LVDS)*
G3	PL19B	7	LDQ21	C (LVDS)*
H7	PL20A	7	LDQ21	T
H5	PL20B	7	LDQ21	C
GND	GNDIO7	-		
H2	PL21A	7	LDQS21	T (LVDS)*
H1	PL21B	7	LDQ21	C (LVDS)*
J6	PL22A	7	LDQ21	T
VCCIO	VCCIO7	7		
J8	PL22B	7	LDQ21	C
J2	PL23A	7	LDQ21	T (LVDS)*
J1	PL23B	7	LDQ21	C (LVDS)*
J5	PL24A	7	LDQ21	T
GND	GNDIO7	-		
J7	PL24B	7	LDQ21	C
J4	PL25A	7	LDQ29	T (LVDS)*
J3	PL25B	7	LDQ29	C (LVDS)*
K6	PL26A	7	LDQ29	T
K8	PL26B	7	LDQ29	C
VCCIO	VCCIO7	7		
K2	PL27A	7	LDQ29	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K28	PR25A	2	RDQ29	T (LVDS)*
J24	PR24B	2	RDQ21	C
J26	PR24A	2	RDQ21	T
GND	GNDIO2	-		
K29	PR23B	2	RDQ21	C (LVDS)*
K30	PR23A	2	RDQ21	T (LVDS)*
J23	PR22B	2	RDQ21	C
J25	PR22A	2	RDQ21	T
VCCIO	VCCIO2	99		
J27	PR21B	2	RDQ21	C (LVDS)*
J28	PR21A	2	RDQS21	T (LVDS)*
H26	PR20B	2	RDQ21	C
GND	GNDIO2	-		
H24	PR20A	2	RDQ21	T
J29	PR19B	2	RDQ21	C (LVDS)*
J30	PR19A	2	RDQ21	T (LVDS)*
H25	PR18B	2	RDQ21	C
VCCIO	VCCIO2	2		
H23	PR18A	2	RDQ21	T
G27	PR15B	2	RUM1_SPLLC_FB_A/RDQ12	C
GND	GNDIO2	-		
H27	PR15A	2	RUM1_SPLLT_FB_A/RDQ12	T
G29	PR14B	2	RUM1_SPLLC_IN_A/RDQ12	C (LVDS)*
G28	PR14A	2	RUM1_SPLLT_IN_A/RDQ12	T (LVDS)*
VCCIO	VCCIO2	2		
GND	GNDIO2	-		
G26	PR6B	2		C (LVDS)*
G25	PR6A	2		T (LVDS)*
G30	PR5B	2		C
F30	PR5A	2		T
VCCIO	VCCIO2	2		
F26	PR4B	2		C (LVDS)*
F27	PR4A	2		T (LVDS)*
F29	PR3B	2		C
GND	GNDIO2	-		
F28	PR3A	2		T
H29	PR2B	2	VREF2_2	C (LVDS)*
H30	PR2A	2	VREF1_2	T (LVDS)*
VCCIO	VCCIO2	2		
B26	PT100B	1	VREF2_1	C
A26	PT100A	1	VREF1_1	T
GND	GNDIO1	-		
C25	PT99B	1		C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG4	NC	-		
AG8	NC	-		
AH1	NC	-		
AH16	NC	-		
AH2	NC	-		
AH26	NC	-		
AH27	NC	-		
AH29	NC	-		
AH30	NC	-		
AH4	NC	-		
AJ1	NC	-		
AJ2	NC	-		
AJ27	NC	-		
AJ28	NC	-		
AJ29	NC	-		
AJ3	NC	-		
AJ30	NC	-		
AK2	NC	-		
AK27	NC	-		
AK28	NC	-		
AK29	NC	-		
AK3	NC	-		
B1	NC	-		
B2	NC	-		
B3	NC	-		
B30	NC	-		
B4	NC	-		
B5	NC	-		
C1	NC	-		
C2	NC	-		
C29	NC	-		
C30	NC	-		
C4	NC	-		
D13	NC	-		
D18	NC	-		
D23	NC	-		
D28	NC	-		
D29	NC	-		
D3	NC	-		
D30	NC	-		
D4	NC	-		
E25	NC	-		
E26	NC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
J2	PL34B	7	LDQ32	C (LVDS)*
H1	PL35A	7	LDQ32	T
GNDIO	GNDIO7	-		
J1	PL35B	7	LDQ32	C
GNDIO	GNDIO7	-		
L5	PL41A	7	LDQ45	T (LVDS)*
L4	PL41B	7	LDQ45	C (LVDS)*
N9	PL42A	7	LDQ45	T
N7	PL42B	7	LDQ45	C
K2	PL43A	7	LDQ45	T (LVDS)*
K1	PL43B	7	LDQ45	C (LVDS)*
P9	PL44A	7	LDQ45	T
P7	PL44B	7	LDQ45	C
GNDIO	GNDIO7	-		
M6	PL45A	7	LDQS45	T (LVDS)*
M5	PL45B	7	LDQ45	C (LVDS)*
N5	PL46A	7	LDQ45	T
N6	PL46B	7	LDQ45	C
M4	PL47A	7	LDQ45	T (LVDS)*
M3	PL47B	7	LDQ45	C (LVDS)*
P6	PL48A	7	LDQ45	T
GNDIO	GNDIO7	-		
P8	PL48B	7	LDQ45	C
L3	PL50A	7	LUM3_SPLLT_IN_A/LDQ54	T (LVDS)*
L2	PL50B	7	LUM3_SPLLC_IN_A/LDQ54	C (LVDS)*
P5	PL51A	7	LUM3_SPLLT_FB_A/LDQ54	T
P4	PL51B	7	LUM3_SPLLC_FB_A/LDQ54	C
L1	PL52A	7	LDQ54	T (LVDS)*
M2	PL52B	7	LDQ54	C (LVDS)*
R5	PL53A	7	LDQ54	T
R4	PL53B	7	LDQ54	C
GNDIO	GNDIO7	-		
M1	PL54A	7	LDQS54	T (LVDS)*
N2	PL54B	7	LDQ54	C (LVDS)*
R8	PL55A	7	LDQ54	T
T9	PL55B	7	LDQ54	C
P3	PL56A	7	LDQ54	T (LVDS)*
P2	PL56B	7	LDQ54	C (LVDS)*
N1	PL57A	7	PCLKT7_0/LDQ54	T
GNDIO	GNDIO7	-		
P1	PL57B	7	PCLKC7_0/LDQ54	C
T5	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
T4	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG2	PB34A	5	BDQ33	T
AG3	PB34B	5	BDQ33	C
AD13	PB35A	5	BDQ33	T
VCCIO	VCCIO5	5		
AC13	PB35B	5	BDQ33	C
AE14	PB36A	5	BDQ33	T
AC14	PB36B	5	BDQ33	C
AF3	PB37A	5	BDQ33	T
GNDIO	GNDIO5	-		
AF4	PB37B	5	BDQ33	C
-	-	-		
AG4	PB38A	5	BDQ42	T
AG5	PB38B	5	BDQ42	C
GNDIO	GNDIO5	-		
-	-	-		
AD11	PB48A	5	BDQ51	T
AF13	PB48B	5	BDQ51	C
AF12	PB49A	5	BDQ51	T
VCCIO	VCCIO5	5		
AD14	PB49B	5	BDQ51	C
AG8	PB50A	5	BDQ51	T
AF8	PB50B	5	BDQ51	C
AE15	PB51A	5	BDQS51****	T
GNDIO	GNDIO5	-		
-	-	-		
AC15	PB51B	5	BDQ51	C
VCCIO	VCCIO5	5		
GNDIO	GNDIO5	-		
AD15	PB56A	5	BDQ60	T
AF15	PB56B	5	BDQ60	C
AG10	PB57A	5	BDQ60	T
AG9	PB57B	5	BDQ60	C
AH14	PB58A	5	BDQ60	T
AG12	PB58B	5	BDQ60	C
VCCIO	VCCIO5	5		
AG15	PB59A	5	BDQ60	T
AG13	PB59B	5	BDQ60	C
GNDIO	GNDIO5	-		
AF16	PB60A	5	BDQS60	T
AH15	PB60B	5	BDQ60	C
AC16	PB61A	5	VREF2_5/BDQ60	T
AE16	PB61B	5	VREF1_5/BDQ60	C
AG11	PB62A	5	PCLKT5_0/BDQ60	T

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M23	GND	-		
M8	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N27	GND	-		
N4	GND	-		
P11	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P20	GND	-		
R10	GND	-		
R11	GND	-		
R13	GND	-		
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R20	GND	-		
R21	GND	-		
R24	GND	-		
R7	GND	-		
T10	GND	-		
T11	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T20	GND	-		
T21	GND	-		
T24	GND	-		
T7	GND	-		
U11	GND	-		
U13	GND	-		
U14	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K11	NC	-			NC	-		
K12	NC	-			NC	-		
K13	NC	-			NC	-		
K23	NC	-			NC	-		
K24	NC	-			NC	-		
K25	NC	-			NC	-		
K26	NC	-			NC	-		
L11	NC	-			NC	-		
L12	NC	-			NC	-		
L13	NC	-			NC	-		
L14	NC	-			NC	-		
L21	NC	-			NC	-		
L22	NC	-			NC	-		
L23	NC	-			NC	-		
L24	NC	-			NC	-		
L25	NC	-			NC	-		
L26	NC	-			NC	-		
M11	NC	-			NC	-		
M24	NC	-			NC	-		
M25	NC	-			NC	-		
M6	NC	-			NC	-		
M8	NC	-			NC	-		
N10	NC	-			NC	-		
N11	NC	-			NC	-		
P10	NC	-			NC	-		
P25	NC	-			NC	-		
P26	NC	-			NC	-		
R9	NC	-			NC	-		
T11	NC	-			NC	-		
U11	NC	-			NC	-		
W11	NC	-			NC	-		
Y10	NC	-			NC	-		
Y11	NC	-			NC	-		
R15	VCCPLL	-			VCCPLL	-		
R20	VCCPLL	-			VCCPLL	-		
Y15	VCCPLL	-			VCCPLL	-		
Y20	VCCPLL	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LatticeECP2 S-Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5TN144C	90	1.2V	-5	Lead-Free TQFP	144	Com	6
LFE2-6SE-6TN144C	90	1.2V	-6	Lead-Free TQFP	144	Com	6
LFE2-6SE-7TN144C	90	1.2V	-7	Lead-Free TQFP	144	Com	6
LFE2-6SE-5FN256C	190	1.2V	-5	Lead-Free fpBGA	256	Com	6
LFE2-6SE-6FN256C	190	1.2V	-6	Lead-Free fpBGA	256	Com	6
LFE2-6SE-7FN256C	190	1.2V	-7	Lead-Free fpBGA	256	Com	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5TN144C	93	1.2V	-5	Lead-Free TQFP	144	Com	12
LFE2-12SE-6TN144C	93	1.2V	-6	Lead-Free TQFP	144	Com	12
LFE2-12SE-7TN144C	93	1.2V	-7	Lead-Free TQFP	144	Com	12
LFE2-12SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	12
LFE2-12SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	12
LFE2-12SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	12
LFE2-12SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	12
LFE2-12SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	12
LFE2-12SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	12
LFE2-12SE-5FN484C	297	1.2V	-5	Lead-Free fpBGA	484	Com	12
LFE2-12SE-6FN484C	297	1.2V	-6	Lead-Free fpBGA	484	Com	12
LFE2-12SE-7FN484C	297	1.2V	-7	Lead-Free fpBGA	484	Com	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	20
LFE2-20SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	20
LFE2-20SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	20
LFE2-20SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	20
LFE2-20SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	20
LFE2-20SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	20
LFE2-20SE-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	Com	20
LFE2-20SE-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	Com	20
LFE2-20SE-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	Com	20
LFE2-20SE-5FN672C	402	1.2V	-5	Lead-Free fpBGA	672	Com	20
LFE2-20SE-6FN672C	402	1.2V	-6	Lead-Free fpBGA	672	Com	20
LFE2-20SE-7FN672C	402	1.2V	-7	Lead-Free fpBGA	672	Com	20

For Further Information

A variety of technical notes for the LatticeECP2/M family are available on the Lattice web site at www.latticesemi.com.

- TN1102, [LatticeECP2/M sysIO Usage Guide](#)
- TN1103, [LatticeECP2/M sysCLOCK PLL Design and Usage Guide](#)
- TN1104, [LatticeECP2/M Memory Usage Guide](#)
- TN1105, [LatticeECP2/M High-Speed I/O Interface](#)
- TN1106, [Power Estimation and Management for LatticeECP2/M Devices](#)
- TN1107, [LatticeECP2/M sysDSP Usage Guide](#)
- TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#)
- TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#)
- TN1113, [LatticeECP2/M Soft Error Detection \(SED\) Usage Guide](#)
- TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#)
- TN1162, [LatticeECP2/M Hardware Checklist](#)

For further information about interface standards refer to the following web sites:

- JEDEC Standards (LVTTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- PCI: www.pcisig.com